




## TS Series



### Features

- Resettable overcurrent protection
- Fast time-to-trip
- Resistance sorted and matched devices available
- Low parasitic capacitance/flat impedance with frequency
- Recognized to UL 1434, approved to CSA TIL No. CA-3A and EN 60730-1.

### Agency Approvals

AGENCY	AGENCY FILE/CERTIFICATE NUMBER
	E74889*
	78166*
	72161787*

\* See Electrical Characteristic Table for approved part numbers.

### Description

Littelfuse PolySwitch products for telecommunication and networking devices help to meet the growing demand for resettable overcurrent protection. They also provide protection against damage caused by power cross and induced power surges as defined by ITU, Telcordia GR1089, and IEC 62368-1. Littelfuse offers chip, surface-mount, and radial-leaded configurations.

### Applications

Networking Machines and Systems:

- Modem
- Phone set
- Fax machine
- Phone wall outlet
- Alarm system
- PBX system
- MDF module
- T1/E1 equipment
- Analog and digital line card
- xDSL modem and splitter
- Powered Ethernet system
- VoIP (Voice over Internet Protocol) equipment
- LAN, WAN equipment
- Customer premise equipment
- Access network hardware

### Additional Information



Datashheet



Resources



Samples

### Electrical Characteristics

Part Number	Ordering Part Number	$I_H$	$I_T$	$V_{MAX}$		$I_{MAX}$	$P_{D\ Typ}$	Max Time-to-trip		$R_{MIN}$	$R_{MAX}$	$R_{TMAX}$	Agency Approvals		
		(A)	(A)	Operating ( $V_{DC}$ )	Interrupt ( $V_{RMS}$ )	Interrupt (A)		(A)	(s)				( $\Omega$ )	( $\Omega$ )	( $\Omega$ )
<b>TS250/TSL250/TSM250/TSV250 – Surface-mount – 250VAC</b>															
TSL250-080F-2	E72246-000	0.080	0.240	80	250	3.0	1.2	1.0	0.8	5.0	11.0	20.0**	x	x	x
TSL250-130F-2	RF3835-000	0.130	0.260	60	250	3.0	1.5	1.0	2.0	4.0	8.0	12.0**	—	—	—
TS250-130F-2	E44331-000	0.130	0.260	60	250	3.0	1.1	1.0	0.9	6.5	12.0	20.0**	x	x	x
		—	—	60	600	1.0	—	—	—	—	—	—			
TS250-130F-RA-2	E18772-000	0.130	0.260	60	250	3.0	1.1	1.0	1.4	6.5	9.0	15.0**	x	x	—
		—	—	60	600	1.0	—	—	—	—	—	—			
TS250-130F-RB-2	D48481-000	0.130	0.260	60	250	3.0	1.1	1.0	0.7	9.0	12.0	20.0**	x	x	—
		—	—	60	600	1.0	—	—	—	—	—	—			
TS250-130F-RC-B-0.5-2	A05570-000	0.130	0.260	60	250	3.0	1.1	1.0	1.1	7.0	10.0	17.0**	x	x	—
		—	—	60	600	1.0	—	—	—	—	—	—			

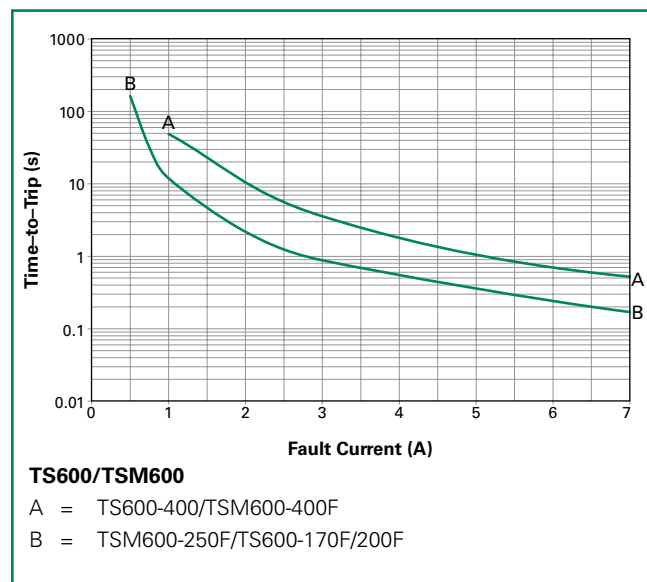
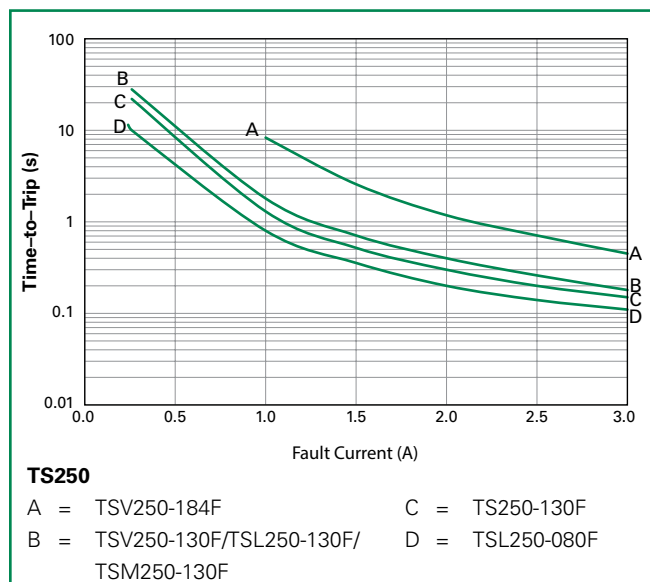
### Electrical Characteristics

Part Number	Ordering Part Number	$V_{MAX}$		$I_{MAX}$		$P_{D\ TYP}$	Max Time-to-trip		$R_{MIN}$	$R_{MAX}$	$R_{1MAX}$	Agency Approvals			
		$I_H$ (A)	$I_T$ (A)	Operating ( $V_{DC}$ )	Interrupt ( $V_{RMS}$ )		(A)	(W)				(A)	(s)	( $\Omega$ )	( $\Omega$ )
<b>TS250/TSL250/TSM250/TSV250 – Surface-mount – 250V<sub>AC</sub></b>															
TSM250-130F-2	RF4825-000	0.130	0.260	60	250	3.0	1.5	1.0	2.4	4.0	9.0	15.0	x	—	—
TSV250-130F-2	F59779-000	0.130	0.260	60	250	3.0	1.5	1.0	2.0	4.0	7.0	12.0**	x	x	x
<b>TS600 – Surface-mount – 600V<sub>AC</sub> (Single Channel)</b>															
TS600-170F-2	D83387-000	0.170	0.400	60	600	3.0	2.5	1.0	10.0	4.0	9.0	18.0	x	x	—
TS600-200F-RA-B-0.5-2	F02483-000	0.200	0.400	60	600	3.0	2.5	1.0	12.0	4.0	7.5	13.5	x	x	—
TS600-400F-2	RF0309-000	0.400	1.000	60	600	3.0	2.0	3.0	5.0	0.5	1.1	2.0	x	x	—
<b>TS600 – Surface-mount – 600V<sub>AC</sub> (Dual Channel)</b>															
TSM600-250F-2	A88766-000	0.250	0.860	250	600	3.0	2.0	3.0	0.8	1.0	3.5	7.0	x	x	—
TSM600-250F-RA-2	A88390-000	0.250	0.860	250	600	3.0	2.0	3.0	1.0	1.0	3.0	5.0	x	x	—
TSM600-400F-2	E12392-000	0.400	1.000	250	600	3.0	2.0	3.0	5.0	0.5	1.1	2.0	x	—	—

**Notes:**

- $I_H$  : Hold current: maximum current device will pass without interruption in 20°C still air.
  - $I_T$  : Trip current: minimum current that will switch the device from low resistance to high resistance in 20°C still air.
  - $V_{MAX\ Operating}$  : Maximum continuous voltage device can withstand without damage at rated current. This voltage is used for component Recognition under UL1434.
  - $V_{MAX\ Interrupt}$  : Maximum voltage that can be safely placed across a device in its tripped state.
  - $I_{MAX\ Interrupt}$  : Maximum fault current device can withstand without damage at rated operating voltage. This current is used for component Recognition under UL1434. Devices may trip safely under higher level power cross conditions to assist equipment in meeting the appropriate ITU, UL60950 or GR1089 industry requirements.
  - $P_D$  : Power dissipated from device when in the tripped state in 20°C still air.
  - $R_{MIN}$  : Minimum resistance of device as supplied at 20°C unless otherwise specified.
  - $R_{MAX}$  : Maximum resistance of device as supplied at 20°C unless otherwise specified.
  - $R_{1MAX}$  : Maximum resistance measured one hour post-trip or post-reflow at 20°C.
- \*\* Applies to all products which share the same prefix.

### Typical Time-to-Trip Curves at 25°C



**Temperature Rerating**

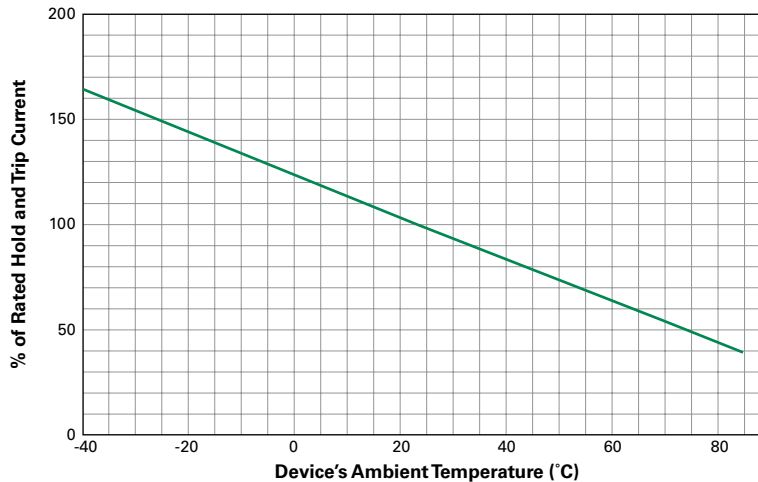
Maximum Ambient Temperature									
Part Number**	-40°C	-20°C	0°C	20°C	40°C	50°C	60°C	70°C	85°C
<b>Hold Current (A)</b>									
<b>TS250/TSL250/TSM250/TSV250 – Surface-mount* – 250V<sub>AC</sub></b>									
TSL250-080F	0.124	0.110	0.095	0.080	0.066	0.059	0.051	0.044	0.033
TSL250-130F	0.208	0.182	0.156	0.130	0.104	0.091	0.078	0.065	0.045
TS250-130F	0.208	0.182	0.156	0.130	0.104	0.091	0.078	0.065	0.045
TSM250-130F	0.208	0.182	0.156	0.130	0.104	0.091	0.078	0.065	0.045
TSV250-130F	0.208	0.182	0.156	0.130	0.104	0.091	0.078	0.065	0.045
TSV250-184F	0.286	0.252	0.218	0.184	0.150	0.134	0.118	0.102	0.075
<b>TS600 – Surface-mount† – 600V<sub>AC</sub> (Single Channel)</b>									
TS600-170F	0.264	0.230	0.200	0.170	0.140	0.125	0.109	0.094	0.070
TS600-200F	0.310	0.275	0.238	0.200	0.165	0.147	0.128	0.110	0.083
TS600-400F	0.640	0.560	0.480	0.400	0.320	0.270	0.230	0.190	0.130
<b>TSM600 – Surface-mount† – 600V<sub>AC</sub> (Dual Channel)</b>									
TSM600-250F	0.400	0.350	0.300	0.250	0.198	0.170	0.140	0.117	0.083
TSM600-400F	0.640	0.560	0.480	0.400	0.320	0.270	0.230	0.190	0.130

\* 250V<sub>AC</sub> interrupt products may help equipment pass ITU K.20, K.21 and K.45 recommendations and Telcordia GR-1089 Port Type 2 and 4 requirements.

† 600V<sub>AC</sub> interrupt products may help equipment pass UL60950, TIA-968-A and GR1089 Port Type 1, 3 and 5 requirements.

\*\* Applies to all products which share the same prefix.

**TSx250/TS600/TSM600 – Temperature Rerating Curve**



### TS250/TSV250/TSM250/TSL250 – Physical Specifications

<b>Terminal Material</b>	Tin-plated Brass, Nickel Under-plating (TS250/TSV250/TSL250) Tin-plated Copper (TSM250)
<b>Soldering Characteristics</b>	IEC 60068-2-58

**Note:** Devices are not intended to be placed through a reflow process.

### TS250/TSV250/TSM250/TSL250 – Environmental Specifications

Test	Conditions
<b>Passive Aging</b>	60°C, 1000 hrs 85°C, 1000 hrs
<b>Humidity Aging</b>	85°C, 85% R.H., 500 hrs
<b>Thermal Shock</b>	125°C, -55°C (10 Times)
<b>Solvent Resistance</b>	MIL-STD-202, Method 215F
<b>Moisture Resistance Level</b>	Level 1, J-STD-020
<b>Storage Conditions</b>	40°C max, 70% RH max; devices should remain in original sealed bags prior to use. Devices may not meet specified values if these storage conditions are exceeded.

### TS600 – Physical Specifications

<b>Terminal Material</b>	Tin-plated Brass
<b>Insulating Material</b>	Nylon Resin (UL94V-0), 1000V Dielectric Rating
<b>Soldering Characteristics</b>	ANSI/J-STD-002, Category 3
<b>Solder Heat Withstand</b>	IEC 60068-2-58, Test Tb, Section 8

### TS600 – Environmental Specifications

Test	Conditions
<b>Passive Aging</b>	60°C, 1000 hrs 85°C, 1000 hrs
<b>Humidity Aging</b>	85°C, 85% R.H., 1000 hrs
<b>Thermal Shock</b>	125°C, -55°C (10 Times)
<b>Solvent Resistance</b>	MIL-STD-202, Method 215F
<b>Moisture Resistance Level</b>	Level 1, J-STD-020
<b>Storage Conditions</b>	40°C max, 70% RH max; devices should remain in original sealed bags prior to use. Devices may not meet specified values if these storage conditions are exceeded.

## TSM600 – Physical Specifications

<b>Terminal Material</b>	Tin-plated Brass
<b>Insulating Material</b>	Nylon Resin (UL94V-0), 1000V Dielectric Rating
<b>Soldering Characteristics</b>	IEC 60068-2-58, Method 7
<b>Solder Heat Withstand</b>	IEC 60068-2-58, Test Tb, Section 5 Method 1a

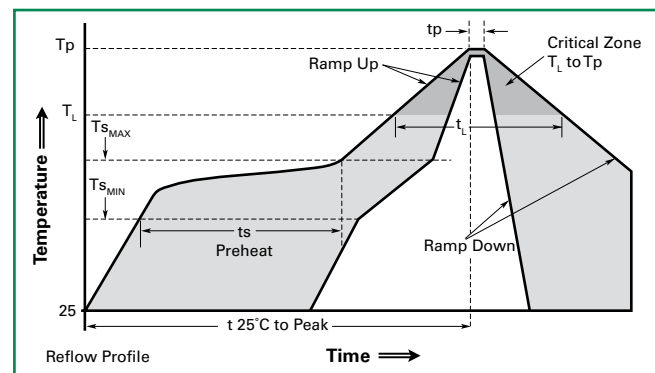
## TSM600 – Environmental Specifications

Test	Conditions
<b>Passive Aging</b>	60°C, 1000 hrs 85°C, 1000 hrs
<b>Humidity Aging</b>	85°C, 85% R.H., 1000 hrs
<b>Thermal Shock</b>	125°C, -55°C (10 Times)
<b>Solvent Resistance</b>	MIL-STD-202, Method 215J
<b>Moisture Resistance Level</b>	Level 2A, J-STD-020
<b>Storage Conditions</b>	40°C max, 70% RH max; devices should remain in original sealed bags prior to use. Devices may not meet specified values if these storage conditions are exceeded.

## Solder Reflow Recommendations

Profile Feature	Pb-Free Assembly
<b>Average ramp up rate (<math>T_{S\_MAX}</math> to <math>T_p</math>)</b>	3°C/s max
<b>Preheat</b>	
• Temperature min ( $T_{S\_MIN}$ )	150°C
• Temperature max ( $T_{S\_MAX}$ )	200°C
• Time ( $t_{S\_MIN}$ to $t_{S\_MAX}$ )	60-180 s
<b>Time maintained above:</b>	
• Temperature ( $T_L$ )	217°C
• Time ( $t_L$ )	60-150 s
<b>Peak/Classification temperature (<math>T_p</math>)</b>	260°C
<b>Time within 5°C of actual peak temperature</b>	
Time ( $t_p$ )	20-40 s
<b>Ramp down rate</b>	6°C/s max
<b>Time 25°C to peak temperature</b>	8min max

**Note:** All temperatures refer to topside of the package, measured on the package body surface.



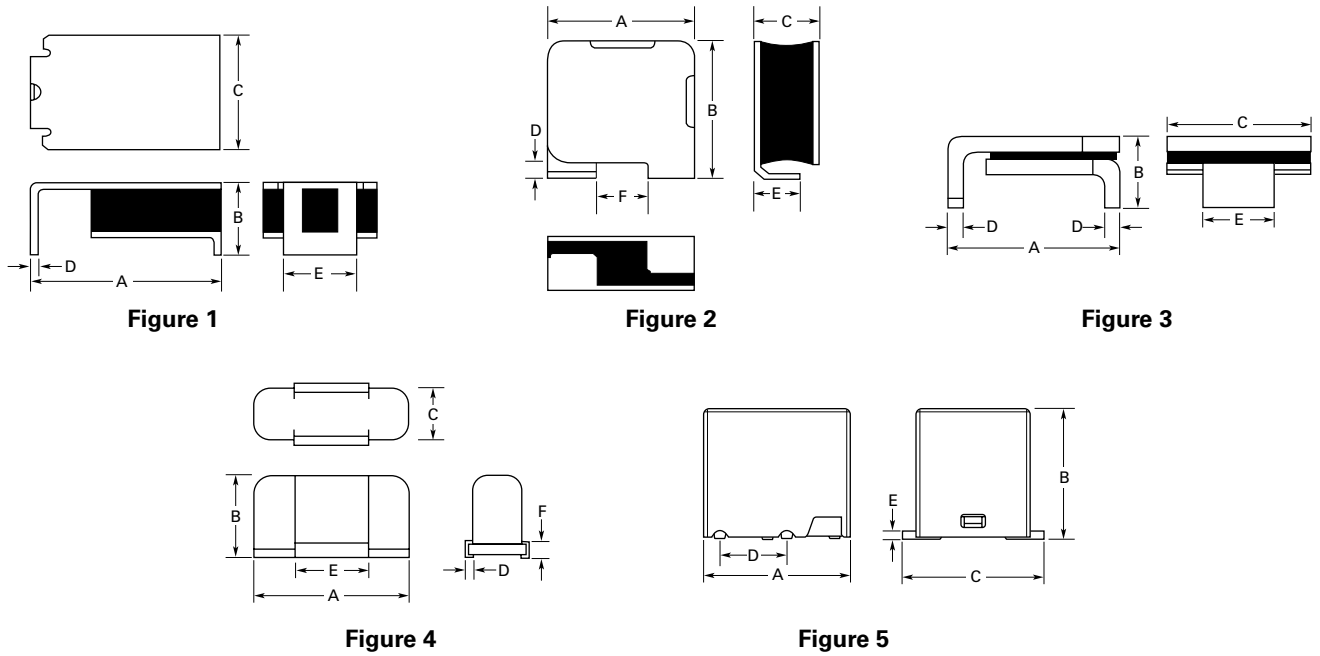
### Solder Reflow

- Recommended reflow method: IR, vapor phase oven, hot air oven.
- Surface-mount devices are not intended to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness of 0.25mm (0.010in).
- Devices can be cleaned using standard industry methods and solvents.

### Rework

- If a device is removed from the board, it should be discarded and replaced with a new device.

**Dimension Figures**

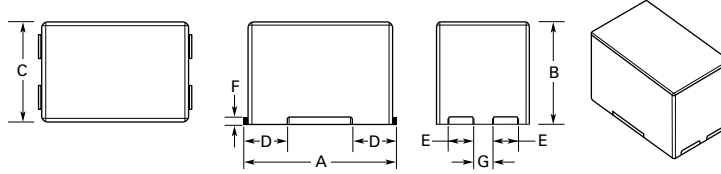


**Dimensions and Weights**

Part Number	Dimensions in Millimeters (Inches)												Figure	Device Mass (g) (Only for Reference)
	A		B		C		D		E		F			
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
<b>TS250/TSL250/TSM250/TSV250 – Surface-mount* – 250V<sub>AC</sub></b>														
TSL250-080F	6.7 (0.27)	7.9 (0.31)	2.7 (0.11)	3.7 (0.15)	4.8 (0.19)	5.3 (0.21)	0.2 (0.01)	0.4 (0.02)	2.5 (0.10)	3.1 (0.12)	—	—	3	2.80
TSL250-130F	6.7 (0.27)	7.9 (0.31)	2.7 (0.11)	3.7 (0.15)	4.8 (0.19)	5.3 (0.21)	0.2 (0.01)	0.4 (0.02)	2.5 (0.10)	3.1 (0.12)	—	—	3	2.80
TS250-130F	8.5 (0.34)	9.4 (0.37)	—	3.4 (0.14)	—	7.4 (0.29)	0.3 <sup>†</sup> (0.01)	—	3.8 <sup>†</sup> (0.15)	—	—	—	1	3.60
TSM250-130F	8.2 (0.323)	8.9 (0.35)	—	9.0 (0.354)	7.8 (0.307)	8.6 (0.339)	—	3.9 (0.154)	—	0.7 (0.026)	—	—	5	0.64
TSV250-130F	—	6.10 (0.24)	—	6.90 (0.27)	—	3.20 (0.13)	0.56 (0.02)	—	—	1.90 (0.08)	1.60 (0.07)	2.30 (0.09)	2	2.80
TSV250-184F	—	6.10 (0.24)	—	6.90 (0.27)	—	3.20 (0.13)	0.56 (0.02)	—	—	1.90 (0.08)	1.60 (0.07)	2.30 (0.09)	2	2.80
<b>TS600 – Surface-mount<sup>†</sup> – 600V<sub>AC</sub> (Single Channel)</b>														
TS600-170F	18.3 (0.72)	19.4 (0.77)	11.6 (0.46)	12.3 (0.49)	7.2 (0.29)	8.3 (0.33)	1.7 (0.07)	2.4 (0.10)	9.9 (0.39)	10.4 (0.41)	1.5 (0.06)	2.3 (0.09)	4	23.6
TS600-200F	18.3 (0.72)	19.4 (0.77)	11.6 (0.46)	12.3 (0.49)	7.2 (0.29)	8.3 (0.33)	1.7 (0.07)	2.4 (0.10)	9.9 (0.39)	10.4 (0.41)	1.5 (0.06)	2.3 (0.09)	4	23.6
TS600-400F	18.3 (0.72)	19.4 (0.77)	11.6 (0.46)	12.3 (0.49)	7.2 (0.29)	8.3 (0.33)	1.7 (0.07)	2.4 (0.10)	9.9 (0.39)	10.4 (0.41)	1.5 (0.06)	2.3 (0.09)	4	19.8

<sup>†</sup> 600V<sub>AC</sub> interrupt products may help equipment pass UL60950, TIA-968-A and GR1089 Port Type 1, 3 and 5 requirements.

**Dimension Figures**



**Figure 6**

**Dimensions and Weights**

Part Number	Dimensions in Millimeters (Inches)														Figure	Device Mass (g) (Only for Reference)
	A		B		C		D		E		F		G			
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
<b>TSM600 – Surface-mount† – 600V<sub>AC</sub> (Dual Channel)</b>																
TSM600-250F	17.0 (0.67)	17.60 (0.69)	11.20 (0.44)	11.70 (0.46)	10.40 (0.41)	11.20 (0.44)	4.80 (0.19)	5.20 (0.20)	2.50 (0.10)	2.80 (0.11)	0.60 (0.02)	1.0 (0.04)	2.2 (0.09)	3.1 (0.12)	6	31.2
TSM600-400F	17.0 (0.67)	17.60 (0.69)	11.20 (0.44)	11.70 (0.46)	10.40 (0.41)	11.20 (0.44)	4.80 (0.19)	5.20 (0.20)	2.50 (0.10)	2.80 (0.11)	0.60 (0.02)	1.0 (0.04)	2.2 (0.09)	3.1 (0.12)	6	31.2

† 600V<sub>AC</sub> interrupt products may help equipment pass UL60950, TIA-968-A and GR1089 Port Type 1, 3 and 5 requirements.

**Packaging and Marking Information**

Part Number	Bag Quantity	Tape and Reel Quantity	Standard Package Quantity	Part Marking	Agency Approvals
<b>TS250/TSL250/TSM250/TSV250 – Surface-mount – 250V<sub>AC</sub></b>					
TSL250-080F-2	—	1,500	7,500	T08	UL, CSA, TÜV
TSL250-130F-2	—	1,500	7,500	T13	—
TS250-130F-2	—	1,500	7,500	T13	UL, CSA, TÜV
TSM250-130F-2	—	600	3,000	T13M	UL
TSV250-130F	2500	—	10,000	T13V	UL, CSA, TÜV
TSV250-130F-2	—	1,200	6,000	T13V	UL, CSA, TÜV
TSV250-184F	2500	—	10,000	T18V	UL
<b>TS600 – Surface-mount – 600V<sub>AC</sub> (Single Channel)</b>					
TS600-170F-2	—	300	900	T20	UL, CSA
TS600-200F-RA-2	—	300	900	T20	UL, CSA
TS600-400F-2	—	300	900	T40	UL, CSA
<b>TSM600 – Surface-mount – 600V<sub>AC</sub> (Dual Channel)</b>					
TSM600-250F-2	—	200	600	TSM600	UL, CSA
TSM600-250F-RA-2	—	200	600	TSM600	UL, CSA
TSM600-400F-2	—	200	600	TSM600-4	UL

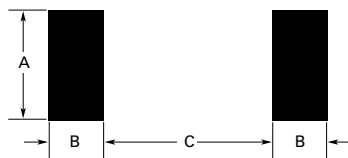


Figure 1

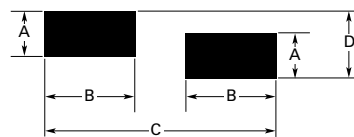


Figure 2

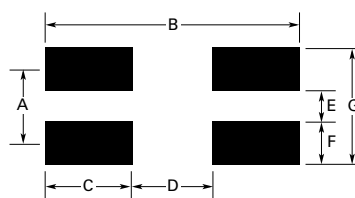


Figure 3

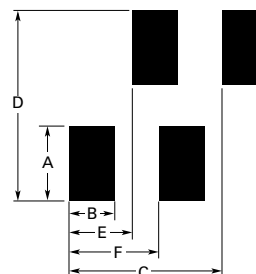


Figure 4

### Recommended Pad Layouts in millimeters (inches) Nominal

Device	A	B	C	D	E	F	G	Figure
TS250 (All)	4.6 (0.180)	1.80 (0.070)	6.10 (0.240)	—	—	—	—	1
TSM250 (All)	3.20 (0.126)	2.00 (0.079)	6.70 (0.264)	8.20 (0.323)	2.60 (0.102)	3.90 (0.154)	—	4
TSV250 (All)	2.29 (0.090)	2.41 (0.095)	6.35 (0.250)	3.43 (0.135)	—	—	—	2
TSL250 (All)	3.6 (0.140)	1.80 (0.070)	5.50 (0.220)	—	—	—	—	1
TS600 (All)	10.42 (0.410)	3.30 (0.130)	3.35 (0.132)	—	—	—	—	1
TSM600 (All)	5.2 (0.205)	17.80 (0.701)	5.54 (0.218)	6.75 (0.266)	2.08 (0.082)	3.12 (0.123)	8.39 (0.331)	3

### Part Ordering Number System

**TSx -200 F -RA -B-0.5 -2**

**Packaging**

2 = Tape and Reel  
(Blank) = Bulk

**B-x.x = Resistance Matched in Bins of x.xΩ (Optional)**

**Rx = Resistance Range (Optional)**

**aRoHS Compliant, ELV Compliant**

**Hold Current (mA)**

**Product Series**

(TS250, TSM250, TSV250, TSL250, TS600, TSM600)



**TS250/TSV250/TSM250/TSL250 – Tape and Reel Specifications**

TS devices are packaged per EIA 481 and EIA 481-2 standards.  
 See Figures 1 and 2 for details.

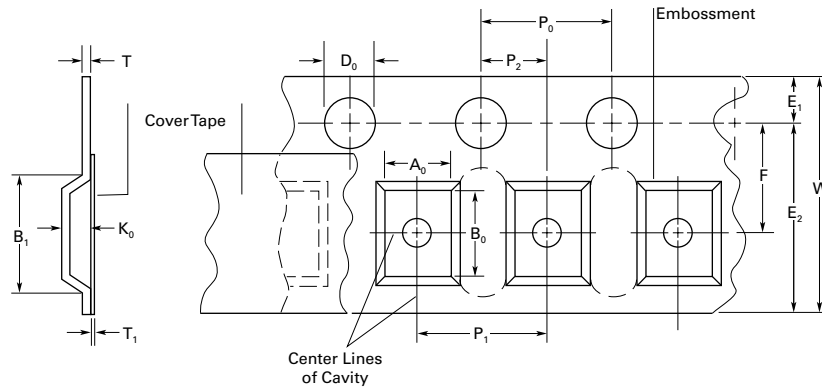
Description	EIA Mark	TS250		TSM250		TSV250		TSL250	
		Dimension (mm)	Tolerance (mm)	Dimension (mm)	Tolerance (mm)	Dimension (mm)	Tolerance (mm)	Dimension (mm)	Tolerance (mm)
Carrier Tape Width	W	16	±0.30	24.0	±0.50	16.0	±0.30	16	±0.30
Sprocket Hole Pitch	P <sub>0</sub>	4.0	±0.10	4.0	±0.10	4.0	±0.10	4.0	±0.10
	P <sub>1</sub>	12.0	±0.10	16.0	±0.10	8.0	±0.10	8.0	±0.10
	P <sub>2</sub>	2.0	±0.10	2.0	±0.10	2.0	±0.10	2.0	±0.10
	A <sub>0</sub>	6.9	±0.23	7.05	±0.20	5.5	±0.10	5.5	±0.10
	B <sub>0</sub>	9.6	±0.15	8.85	±0.20	6.2	±0.10	7.9	±0.10
	B <sub>1</sub> max	12.1	—	12.45	—	8.0	—	9.2	—
Sprocket Hole Diameter	D <sub>0</sub>	1.5	-0/+0.1	1.5	-0/+1.0	1.55	±0.05	1.55	±0.05
	F	7.5	±0.10	11.5	±0.10	7.5	±0.10	7.5	±0.10
	E <sub>1</sub>	1.75	±0.10	1.75	±0.10	1.75	±0.10	1.75	±0.10
	E <sub>2</sub> min	14.25	—	22.25	—	—	—	—	—
Tape Thickness	T max	0.4	—	0.5	±0.50	0.45	—	0.35	—
Tape Thickness with Splice Cover Tape Thickness	T <sub>1</sub> max	0.1	—	0.1	—	0.1	—	0.1	—
	K <sub>0</sub>	3.4	±0.15	8.55	±0.20	7.0	±0.10	3.70	±0.10
	Leader min	300	—	300	—	390	—	390	—
	Trailer min	300	—	160	—	160	—	160	—
<b>Reel Dimensions</b>									
Reel Diameter	A max	340	—	390	—	340	—	340	—
Core Diameter	N min	50	—	75	—	50	—	50	—
Space between Flanges-less Device	W <sub>1</sub>	16.4	-0/+2.0	25.4	±0.5	16.4	-0/+2.0	16.4	-0/+2.0
Reel Width	W <sub>2</sub> max	22.4	—	30.4	—	22.4	—	22.4	—

**TS600/TSM600 – Tape and Reel Specifications**

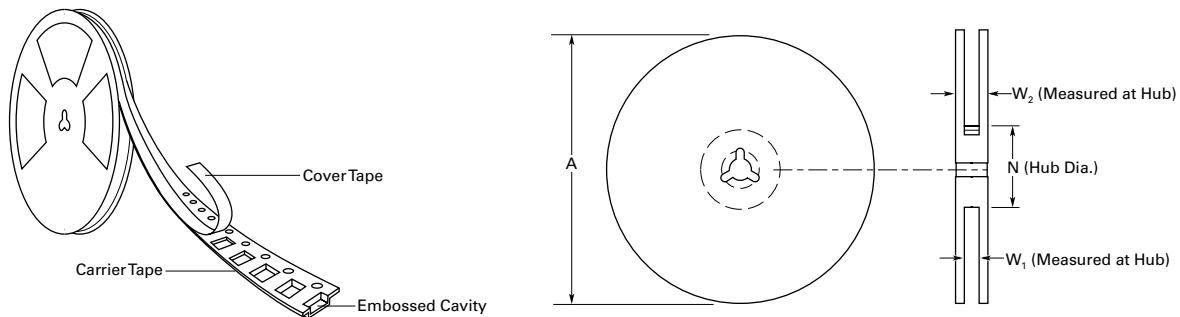
TS devices are packaged per EIA 481 and EIA 481-2 standards.  
 See Figures 1 and 2 for details.

Description	EIA Mark	TS600		TSM600	
		Dimension (mm)	Tolerance (mm)	Dimension (mm)	Tolerance (mm)
Carrier Tape Width	W	32	±0.3	32	±0.3
Sprocket Hole Pitch	P <sub>0</sub>	4.0	±0.1	4.0	±0.1
	P <sub>1</sub>	16	±0.1	24	±0.1
	P <sub>2</sub>	2.0	±0.1	2.0	±0.1
	A <sub>0</sub>	10	±0.1	11.2	±0.1
	B <sub>0</sub>	19.2	±0.1	17.8	±0.1
	B <sub>1</sub> max	21.6	—	23.45	—
Sprocket Hole Diameter	D <sub>0</sub>	1.5	-0/+1.0	1.5	-0/+1.0
	F	14.2	±0.1	14.2	±0.1
	E <sub>1</sub>	1.75	±0.1	1.74	±0.1
	E <sub>2</sub> min	28.4	±0.1	28.4	±0.1
Tape Thickness	T max	0.50	±0.5	0.5	±0.5
Tape Thickness with Splice	T <sub>1</sub> max	0.1	—	0.1	—
	K <sub>0</sub>	13.2	±0.1	11.9	±0.1
	Leader min	390	—	390	—
	Trailer min	160	—	160	—
<b>Reel Dimensions</b>					
Reel Diameter	A max	360	—	360	—
Core Diameter	N min	50	—	50	—
Space between Flanges-less Device	W <sub>1</sub>	32.4	-0/+2.0	32.4	-0/+2.0
Reel Width	W <sub>2</sub> max	40	—	40	—

**Tape and Reel Diagrams**



**Figure 1**



**Figure 2**

**WARNING**

- Users should independently evaluate the suitability of and test each product selected for their own application.
- Operation beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- These devices are intended for protection against damage caused by occasional overcurrent or overtemperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Contamination of the PPTC material with certain silicone-based oils or some aggressive solvents can adversely impact the performance of the devices.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
- PPTC devices are not recommended for installation in applications where the device is constrained such that its PTC properties are inhibited, for example in rigid potting materials or in rigid housings, which lack adequate clearance to accommodate device expansion.
- Operation in circuits with a large inductance can generate a circuit voltage ( $Ldi/dt$ ) above the rated voltage of the device.

**Disclaimer Notice** - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at [www.littelfuse.com/disclaimer-electronics](http://www.littelfuse.com/disclaimer-electronics).